MOSFET – Single, N-Channel, Small Signal, SC-88

25 V, 1.2 A

Features

- Advance Planar Technology for Fast Switching, Low RDS(on)
- Higher Efficiency Extending Battery Life
- AEC-Q101 Qualified and PPAP Capable NVJS4405N
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Boost and Buck Converter
- Load Switch
- Battery Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	25	V
Gate-to-Source Voltage			V _{GS}	± 8.0	V
Drain Current	$t < 5 \text{ s}$ $T_A = 25^{\circ}C$		۱ _D	1.2	А
Continuous Drain Current	$\begin{array}{c} \text{Continuous Drain Current}\\ \text{(Note 1)} \end{array} \begin{array}{c} \text{Steady}\\ \text{State} \end{array} \begin{array}{c} \text{T}_{\text{A}} = 25^{\circ}\text{C}\\ \text{T}_{\text{A}} = 75^{\circ}\text{C} \end{array}$		I _D	1.0	А
(Note T)				0.80	
Power Dissipation (Note 1)	Power Dissipation (Note 1) Steady State			0.63	W
Power Dissipation (Note 1)	t≤	≤ 5 s	PD	0.89	W
Pulsed Drain Current	t _p =	10 μs	I _{DM}	3.7	А
Operating Junction and Sto	T _J , T _{STG}	–55 to +150	°C		
Source Current (Body Dioc	۱ _S	0.8	А		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C
ESD Rating – Machine Mo		25	V		

THERMAL RESISTANCE RATINGS

Rating	Symbol	Мах	Unit
Junction-to-Lead - Steady State (Note 1)	$R_{\theta JL}$	102	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	200	
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	140	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface mounted on FR4 board using 1 in sq pad size

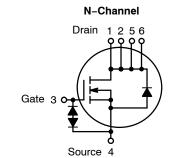
(Cu area = 1.127 in sq [1 oz] including traces).



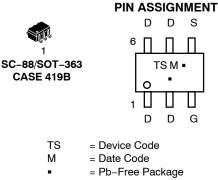
ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max	
25 V	249 mΩ @ 4.5 V	1.2 A	
	299 mΩ @ 2.7 V		



MARKING DIAGRAM &



(Note: Microdot may be in either location)

ORDERING INFORMATION

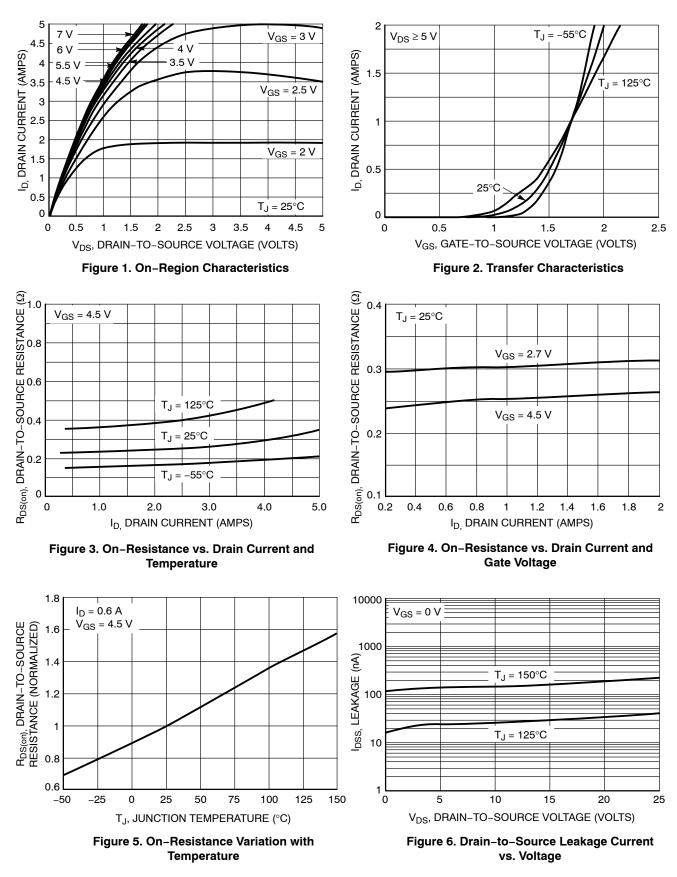
Device		Package	Shipping†
NTJS4405N	IT1G	SC-88 (Pb-Free)	3000 / Tape & Reel
NVJS4405N	IT1G	SC-88 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

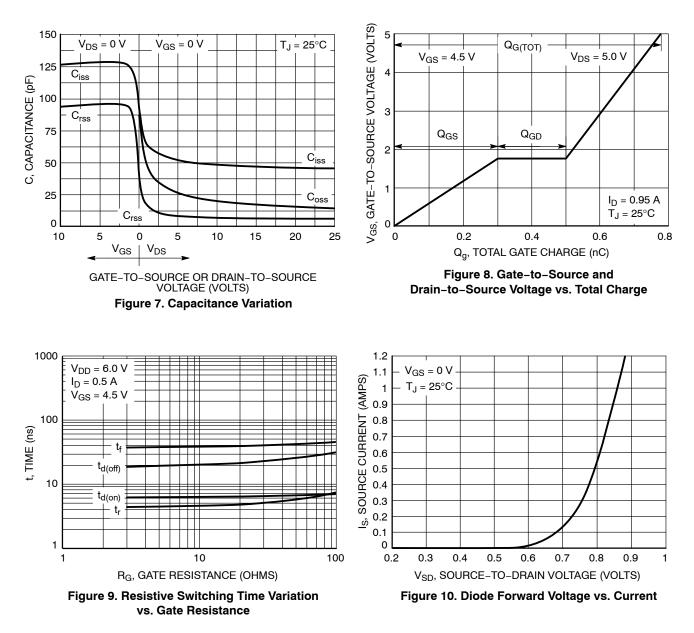
Characteristic	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	-	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		25			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				30		mV/°C
Zero Gate Voltage Drain Current	I_{DSS} $V_{CS} = 0.V$	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{\rm DS} = 20$ V	$T_J = 125^{\circ}C$			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 8.0 V				100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 250 μA	0.65		1.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$R_{DS(on)} = \frac{V_{GS} = 4.5 \text{ V}, I_D = 0.6 \text{ A}}{V_{GS} = 2.7 \text{ V}, I_D = 0.2 \text{ A}}$			249	350	mΩ
					299	400	
	V _{GS} = 4.5 V		_D = 1.2 A		260		
Forward Transconductance	9fs	V _{DS} = 5.0 V, I _D = 0.5 A			0.5		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				49	60	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = V _{DS} = 1	1.0 MHz, 0 V		22.4	30	
Reverse Transfer Capacitance	C _{RSS}	. 50			8.0	12	
Total Gate Charge	Q _{G(TOT)}				0.75	1.5	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _I	_{DS} = 5.0 V,		0.10		
Gate-to-Source Charge	Q _{GS}	l _D = 0.9	5 A		0.30	0.50	
Gate-to-Drain Charge	Q _{GD}				0.20	0.40	
SWITCHING CHARACTERISTICS (No	te 3)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V _{DS} = 6.0 V, I _D = 0.5 A, R _G = 50 Ω			6.0	12	ns
Rise Time	t _r				4.7	8.0	7
Turn-Off Delay Time	t _{d(OFF)}				25	35	
Fall Time	t _f				41	60	
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 0.6 A	$T_J = 25^{\circ}C$		0.82	1.20	V

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



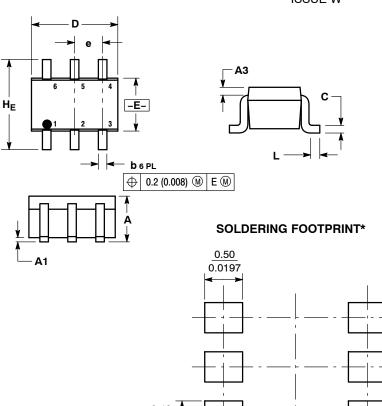
TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE W**



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

CONTROLLING DIMENSION: INCH. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.95	1.10	0.031	0.037	0.043	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A3	0.20 REF			0.008 REF			
b	0.10	0.21	0.30	0.004	0.008	0.012	
С	0.10	0.14	0.25	0.004	0.005	0.010	
D	1.80	2.00	2.20	0.070	0.078	0.086	
Е	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012	
HE	2.00	2.10	2.20	0.078	0.082	0.086	

0.65 0.025 0.65 0.025 0.40 0.0157 1.9 0.0748 $\left(\frac{mm}{inches}\right)$ SCALE 20:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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